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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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ModSTACK™

2LS20017E42W36702



Preliminary data

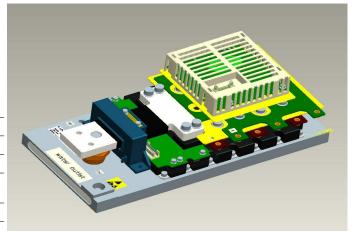
General information

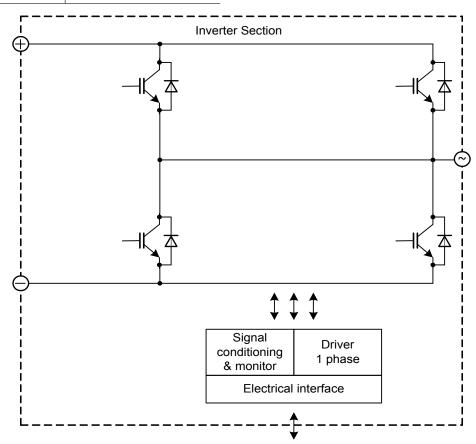
IGBT Stack for typical voltages of up to 690 V_{RMS} Rated output current 1520 A_{RMS}

- High power converterWind powerMotor drives

- $\cdot \ \mathsf{PrimePACK}^{\mathsf{TM}} \mathsf{3} \ \mathsf{module}$
- · Extended operational temperature · Low V_{cesat}

Topology	¹ / ₂ B2I
Application	Inverter
Load type	Resistive, inductive
Semiconductor (Inverter Section)	2x FF1000R17IE4
Heatsink	Water cooled
Implemented sensors	Current, temperature
Driver signals IGBT	Electrical
Design standards	EN 50178
Sales - name	2LS20017E42W36702
SP - No.	SP000934308





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Absolute maximum rated values

Collector-emitter voltage	IGBT; T _{vj} = 25°C	V _{CES}	1700	V
Repetitive peak reverse voltage	Diode; T _{vj} = 25°C	V _{RRM}	1700	V
DC link voltage		V _{DC}	1250	V
Insulation management	according to installation height of 2000 m	V _{line}	690	V _{RMS}
Insulation test voltage		V _{ISOL}	2.5	kV _{RMS}
Repetitive peak collector current inverter section (IGBT)	$t_p = 1 \text{ ms}$	I _{CRM2}	2500	A
Repetitive peak forward current inverter section (Diode)	$t_p = 1 \text{ ms}$	I _{FRM2}	2500	А
Continuous current inverter section		I _{AC2}	1660	A _{RMS}
Junction temperature	under switching conditions	T _{vjop}	150	°C
Switching frequency inverter section		f _{sw2}	4	kHz

Notes

Further maximum ratings are specified in the following dedicated sections

Characteristic values

Inverter Section			min.	typ.	max.	
Rated continuous current	$ \begin{aligned} V_{DC} &= 1100 \text{ V}, V_{AC} = 690 \text{ V}_{RMS}, cos(\phi) = 0.85, \\ f_{AC \text{ sine}} &= 50 \text{ Hz}, f_{sw} = 2000 \text{ Hz}, T_{inlet} = 40^{\circ}C, T_{j} \leq 150 ^{\circ}C \end{aligned} $	I _{AC}			1520	A _{RMS}
Continuous current at low frequency	$\begin{aligned} V_{DC} &= 1100 \text{ V}, V_{AC} = 690 \text{ V}_{RMS}, f_{AC \text{ sine}} = 0 \text{ Hz}, \\ f_{sw} &= 2000 \text{ Hz}, T_{inlet} = 40 \text{ °C}, T_{j} \leq 150 \text{ °C} \end{aligned}$	I _{AC low}			770	A _{RMS}
Rated continuous current for 150% overload capability	$I_{AC\ 150\%}$ = 1660 A _{RMS} , $t_{on\ over}$ = 3 s, $T_{j} \le$ 150 °C	I _{AC over1}			1110	A _{RMS}
Over current shutdown	within 15 μs	I _{AC} oc		4200		A _{peak}
Power losses	$ \begin{vmatrix} I_{AC} = 1520 \text{ A, V}_{DC} = 1100 \text{ V, V}_{AC} = 690 \text{ V}_{RMS}, \\ \cos(\phi) = 0.85, f_{AC \text{ sine}} = 50 \text{ Hz, f}_{sw} = 2000 \text{ Hz,} \\ T_{inlet} = 40 \text{ °C, T}_{j} \leq 150 \text{ °C} $	P _{loss}		6700		W

Controller interface

Driver and interface board	ref. to separate Application Note			DR240		
			min.	typ.	max.	
Auxiliary voltage		V_{aux}	18	24	30	V
Auxiliary power requirement	V _{aux} = 24 V	Paux			40	W
Digital input level resistor to GND 1.8 k Ω , capacitor to logic high = on, min. 15 mA	resistor to GND 1.8 kΩ, capacitor to GND 4 nF,	V _{in low}	0		4	V
	logic high = on, min. 15 mA	V _{in high}	11		15	V
Digital output level	open collector, logic low = no fault, max. 15 mA	V _{out low}	0		1.5	V
		V _{out high}		15		V
Analog current sensor output inverter section	load max 1 mA, @ 1520 A _{RMS}	V _{IU} ana2 V _{IV} ana2 V _{IW} ana2	3.3	3.4	3.5	V
Analog temperature sensor output inverter section (NTC)	load max 1 mA, @T _{NTC} = 66 °C, corresponds to T _j = 150 °C at rated conditions	V _{Theta NTC2}	6.4	6.5	6.6	٧
Over temperature shutdown inverter section	load max 1 mA, @T _{NTC} = 75 °C	V _{Error OT2}		8.6		٧

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System data				min.	typ.	max.	
EMC robustness	according to IEC 61800-3 at named	power	V _{Burst}	2		kV	
Zivio robuotinoco	interfaces	control	V _{Burst}		1		kV
		aux (24V)	V_{surge}		1		kV
Storage temperature			T_{stor}	-40		80	°C
Operational ambient temperature	PCB, bus bar, excluding cooling medium	1	T _{op amb}	-25		55	°C
Humidity	no condensation		Rel. F	0		95	%
Vibration						5	m/s²
Shock						40	m/s²
Protection degree					IP00		
Pollution degree					2		
Dimensions	width x depth x height			205	400	117	mm
Weight					9		kg

Heatsink water cooled min. max. typ. Water flow according to coolant specification from Infineon $\Delta V/\Delta t$ 15 dm³/min Water pressure bar Water pressure drop 60 mbar Δp Coolant inlet temperature -40 55 °C $T_{\text{inlet}} \\$

Notes

Composition of coolant: Water and 52 vol. % Antifrogen N

Overview of optional components	Unit 1	Inverter Section	Unit 3
Parallel interface board			
Optical interface board			
Voltage sensor			
Current sensor		×	
Temperature sensor		×	
Temperature simulation			
DC link capacitors			
Data cable for control signals			
Collector for water cooled heatsink			
Collector-emitter Active Clamping		×	

Notes

Setting of Active Clamping TVS-Diodes: V_Z = 1280 V

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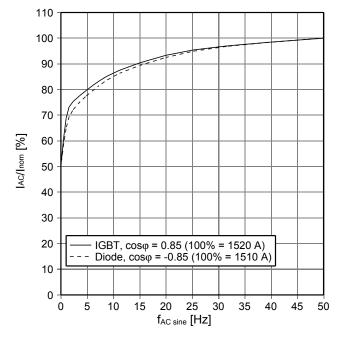
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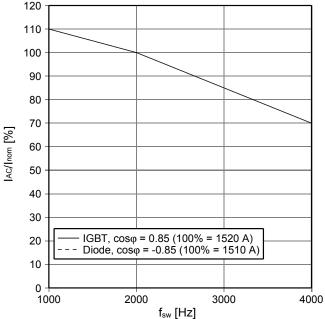


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 $\begin{array}{l} f_{\text{AC sine}} \text{ - derating curve IGBT (motor), Diode (generator)} \\ V_{\text{DC}} = 1100 \text{ V}, \text{ V}_{\text{AC}} = 690 \text{ V}_{\text{RMS}}, f_{\text{sw}} = 2 \text{ kHz, } cos\phi = \pm 0.85, \\ T_{\text{inlet}} = 40 \text{ °C and nom. cooling conditions} \end{array}$

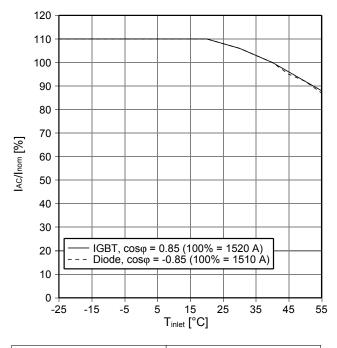
$$\begin{split} f_{\text{sw}} &- \text{derating curve IGBT (motor), Diode (generator)} \\ V_{\text{DC}} &= 1100 \text{ V}, \text{ V}_{\text{AC}} = 690 \text{ V}_{\text{RMS}}, f_{\text{AC sine}} = 50 \text{ Hz, } \cos \varphi = \pm 0.85, \\ T_{\text{inlet}} &= 40 \text{ °C and nom. cooling conditions} \end{split}$$

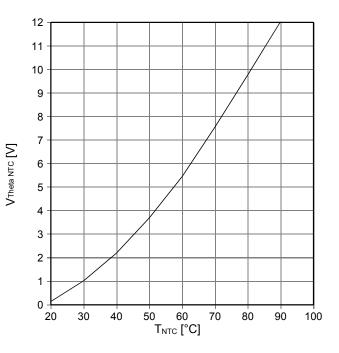




$$\begin{split} &T_{\text{inlet}} \text{- derating curve IGBT (motor), Diode (generator)} \\ &V_{\text{DC}} = 1100 \text{ V}, \text{ V}_{\text{AC}} = 690 \text{ V}_{\text{RMS}}, f_{\text{sw}} = 2 \text{ kHz, } f_{\text{AC sine}} = 50 \text{ Hz,} \\ &cos\phi = \pm 0.85 \text{ and nom. cooling conditions} \end{split}$$

Analog temperature sensor output $V_{\text{Theta NTC}}$ Sensing NTC of IGBT module





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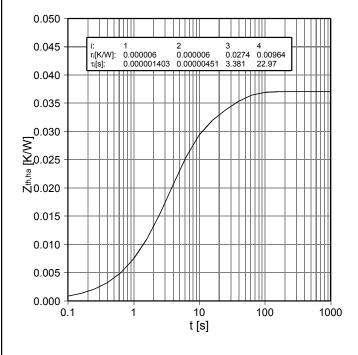
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 $Z_{\text{th,ha}} \text{ - thermal impedance heatsink to ambient per switch} \\ \text{nom. cooling conditions}$



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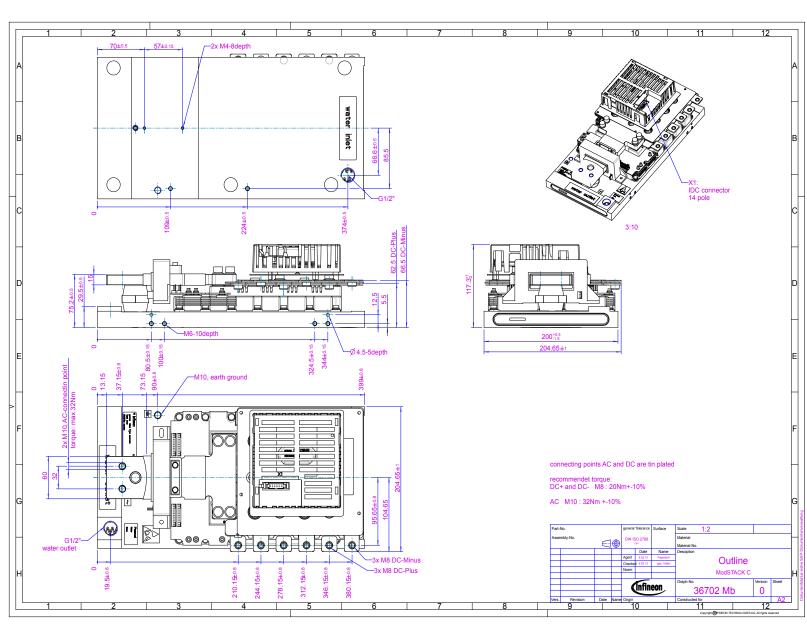
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Mechanical drawing



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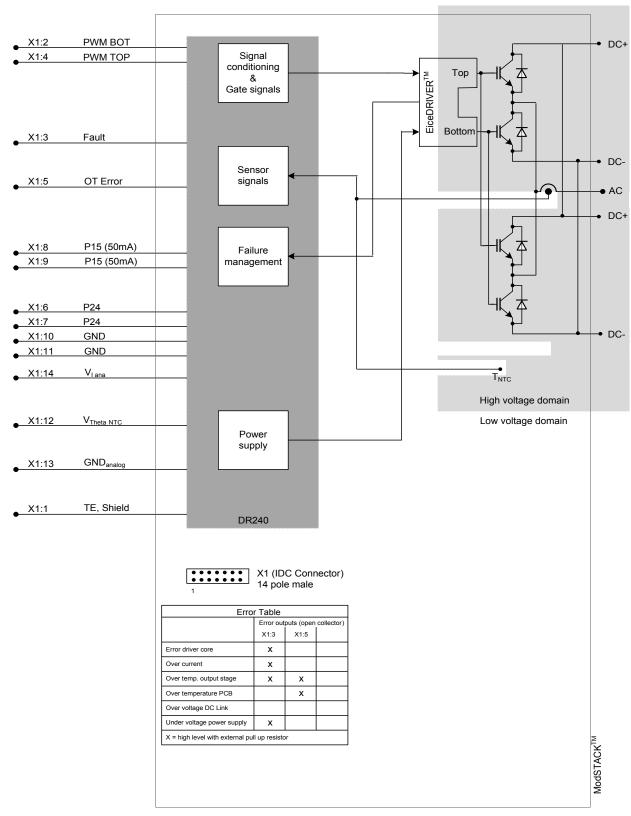
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Circuit diagram



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Prior to installation and operation, all safety notices and warnings and all warning signs attached to the equipment have to be carefully read. Make sure that all warning signs remain in a legible condition and that missing or damaged signs are replaced. To installation and operation, all safety notices and warnings and all warning signs attached to the equipment have to be carefully read. Make sure that all warning signs remain in a legible condition and that missing or damaged signs are replaced.

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